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<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>				<b>Application Number</b>	Unassigned
				<b>Filing Date</b>	April 9, 2004
				<b>First Named Inventor</b>	Tomohiro IINO
				<b>Group Art Unit</b>	2852
				<b>Examiner Name</b>	Unassigned
(use as many sheets as necessary)				<b>Attorney Docket Number</b>	016907-1655
Sheet	1	of	1		

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.		T <sup>6</sup>

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